

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

HIGH PRESSURE PROCESSING CHAMBER FOR SEMICONDUCTOR SUBSTRATE

Application Number : 09/912844



Confirmation Number: 5915

First Named Applicant: Maximilian Biberger

Attorney Docket Number:

Art Unit:

Examiner:

Search string: (3681171 or 4827867 or 5009738 or 6221781 or 6306564 or 6497239 or 20030005948).pn

Certification: This Information Disclosure Statement was submitted under the following conditions, which satisfies the requirement under 37 CFR 1.97(e). The filer certified:

That each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
1	1	3681171	1972-08-01	Toku Hojo et al.			
2	2	4827867	1989-05-09	Takei et al.			
3	3	5009738	1991-04-23	Gruenwald et al.			
4	4	6221781	2001-04-24	Siefering et al.	B1		
5	5	6306564	2001-10-23	Mullee	B1		
6	6	6497239	2002-12-24	Farmer et al.	B2		

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
1	1	20030005948	2003-01-09	Matsuno et al.	A1		

Signature *Rams*

5-2-2005

2-15-05

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Search string: (3689025 or 5679169 or 6021791 or 6109296 or 6465403 or 6509141 or 6635565 or 6641678).pn

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That no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of the information disclosure statement.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	3689025	1972-09-05	Kiser			
	2	5679169	1997-10-21	Gonzales et al.			
	3	6021791	2000-02-08	Dryer et al.			
	4	6109296	2000-08-29	Austin			
	5	6465403	2002-10-15	Skee	B1		
	6	6509141	2003-01-21	Mullee	B2		
	7	6635565	2003-10-21	Wu et al.	B2		
	8	6641678	2003-11-04	DeYoung et al.	B2		

Signature

Examiner Name	Date
Randy Karker	5-2-2005

4-07-05

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Search string: (4391511 or 6722642).pn

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US Patent Documents

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init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	4391511	1983-07-05	Akiyama et al.			
	2	6722642	2004-04-20	Sutton et al.	B1		

Signature

Examiner Name	Date
Ram N Karkar	5-2-2005